

ICESTARS

Construction of an electromagnetic – TCAD transient solver: Interface & boundary condition subtleties

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Overview

- ▶ Introduction
- ▶ Transient Electromagnetic-TCAD
- ▶ Interface conditions
- ▶ Boundary conditions
- ▶ Conclusions



Introduction

▶ Aim of the work:

- Support to circuit model development of devices by applying first-principle evaluation of electromagnetic responses
- Replacement of circuit models by full-wave characterizations
- Allowance of these approaches directly in the time regime

▶ This requires two developments:

- Construction of a transient field solver for semiconductors and large-signal electromagnetic fields
- Construction of a circuit-field co-simulation framework



Transient Electromagnetic-TCAD

- ▶ The transient electromagnetic-TCAD equations are:

$$\begin{aligned}\nabla \cdot \mathbf{D} &= \rho \\ \nabla \cdot \mathbf{B} &= 0 \\ \nabla \times \mathbf{E} + \frac{\partial \mathbf{B}}{\partial t} &= 0 \\ \nabla \times \mathbf{H} &= \mathbf{J} + \frac{\partial \mathbf{D}}{\partial t}\end{aligned}$$

Maxwell equations

Conductors

$$\begin{aligned}\nabla \cdot \mathbf{J} &= -j\omega\rho \\ \mathbf{J} &= \sigma \mathbf{E}\end{aligned}$$

Semi-conductors

$$\begin{aligned}\nabla \cdot \mathbf{J}_n - q j\omega n &= U(n, p) \\ \nabla \cdot \mathbf{J}_p + q j\omega p &= -U(n, p) \\ \rho &= q(p - n + N_D - N_A) \\ \mathbf{J}_n &= q\mu_n n \mathbf{E} + kT\mu_n \nabla n \\ \mathbf{J}_p &= q\mu_p p \mathbf{E} - kT\mu_p \nabla p \\ \mathbf{J} &= \mathbf{J}_n + \mathbf{J}_p\end{aligned}$$

Drift
(EM)

Diffusion
(TCAD)

Transient Electromagnetic-TCAD

- ▶ TCAD solves for
 - Voltages V , and carrier densities n , p or V , ϕ_p , ϕ_n but NOT \mathbf{E}
- ▶ Set up the Maxwell equations in potential formulation V , \mathbf{A}

Gauss

$$-\nabla \cdot \left(\epsilon \nabla V + \frac{\partial \mathbf{A}}{\partial t} \right) = \rho(V, \mathbf{A})$$

Maxwell-Ampere →

$$\nabla \times \nabla \times \mathbf{A} = \mu \mathbf{J}(V, \mathbf{A}) - \mu \epsilon \frac{\partial}{\partial t} \left(\nabla V + \frac{\partial \mathbf{A}}{\partial t} \right)$$

Gauge condition →

$$\nabla \cdot \mathbf{A} + \frac{\xi}{c^2} \frac{\partial V}{\partial t} = 0, \quad \xi = 1 \text{ Lorentz}$$

$$\mathbf{E} = -\nabla V - \frac{\partial \mathbf{A}}{\partial t}$$

$$\mathbf{B} = \nabla \times \mathbf{A}$$

$$\mathbf{D} = \epsilon \mathbf{E}$$

$$\mathbf{B} = \mu \mathbf{H}$$

System
to be
solved

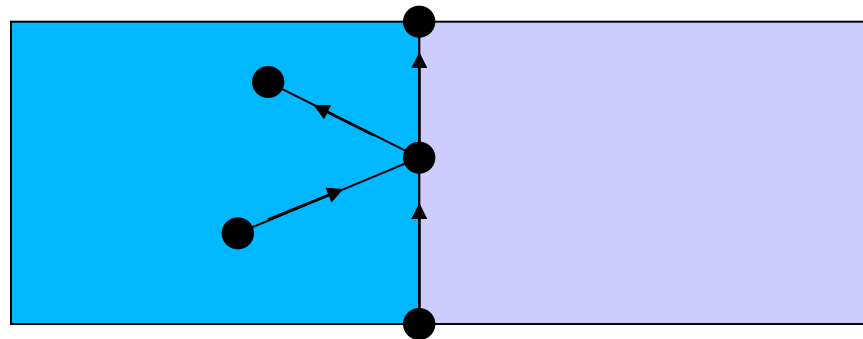
TCAD experience

- ▶ Use Gauss' law to compute V
- ▶ In insulators Gauss' law is used to compute V
- ▶ Use the current-continuity equations to compute ϕ_p, ϕ_n
- ▶ Metals are usually 'ignored' (i.e. replaced by ideal boundary conditions)
- ▶ For skin effects, induced substrate currents this is not permissible.
- ▶ We must now treat metals using Ohm's law: this gives (again) an equation for V



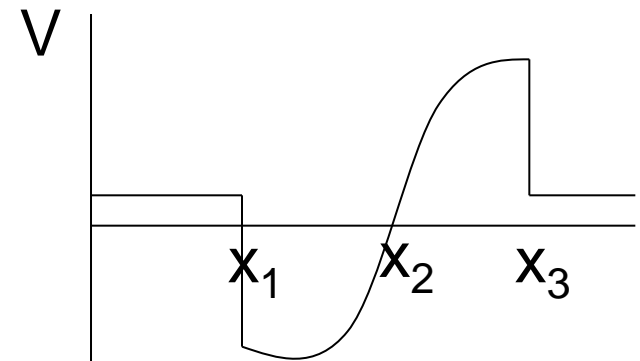
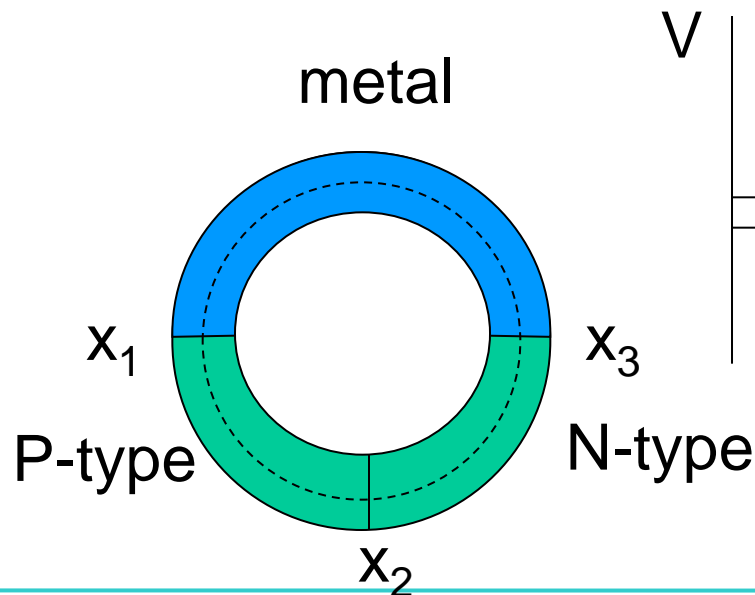
Interfaces: metal/insulator

- ▶ What to do at metal/insulator interface points?
- ▶ Should we use Gauss' law or/and Ohm's law?
- ▶ At metal/insulator interface points, there is current present
- ▶ **use Ohm's law to compute V**
- ▶ Next, Gauss' law is used for computing the surface charge at these nodes.



Interfaces: metal/semiconductor

- ▶ The metal/semiconductor interface nodes also carry current
- ▶ **use Ohm's law to compute V**
- ▶ However, doping generates a build-in potential
- ▶ Fixed voltage jump, when passing through an M/S interface
- ▶ Consider a donut of a diode and metal

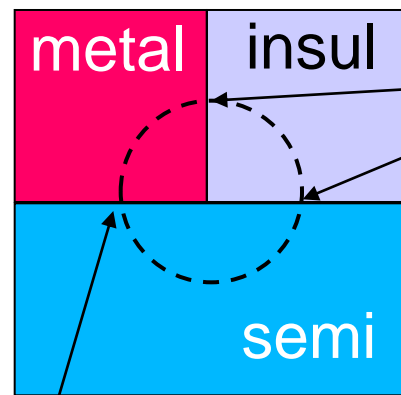


Interfaces: metal/semiconductor

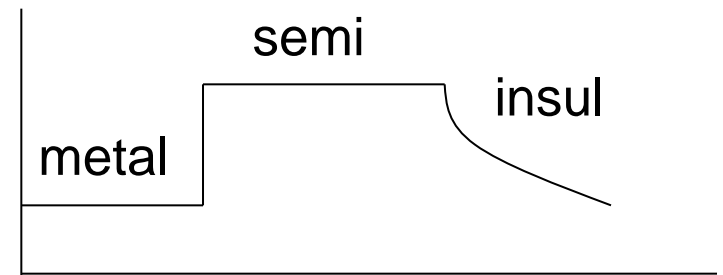
- ▶ $V_{\text{semi}} = V_{\text{metal}} - \delta V$
- ▶ $\phi_p = \phi_n = V_{\text{metal}}$
- ▶ For the carrier concentrations we assume infinitely large recombination velocities
- ▶ $p - n + N_D = 0$ and $pn = n_i^2$
- ▶ This allows us to obtain δV from the doping
- ▶ **Only one variable (V) is computed at M/S interfaces!**

Triple points: metal/semiconductor/insulator

- ▶ Take half-sized jumps @ triple points (lines)
- ▶ The voltage plots can give 'counter-intuitive' results due to penetration of the built-in potential into insulators



No discontinuity



discontinuity

Boundary conditions

- ▶ Internal boundary conditions
 - These are boundary conditions mimicking actual measurements set ups.
- ▶ External boundary conditions
 - These are the boundary conditions for the surface of the simulation domain
- ▶ Beware that there are **four** or **six** fields to be computed!

V , A_x , A_y , A_z and possibly ϕ_p , ϕ_n

Boundary conditions: Dirichlet

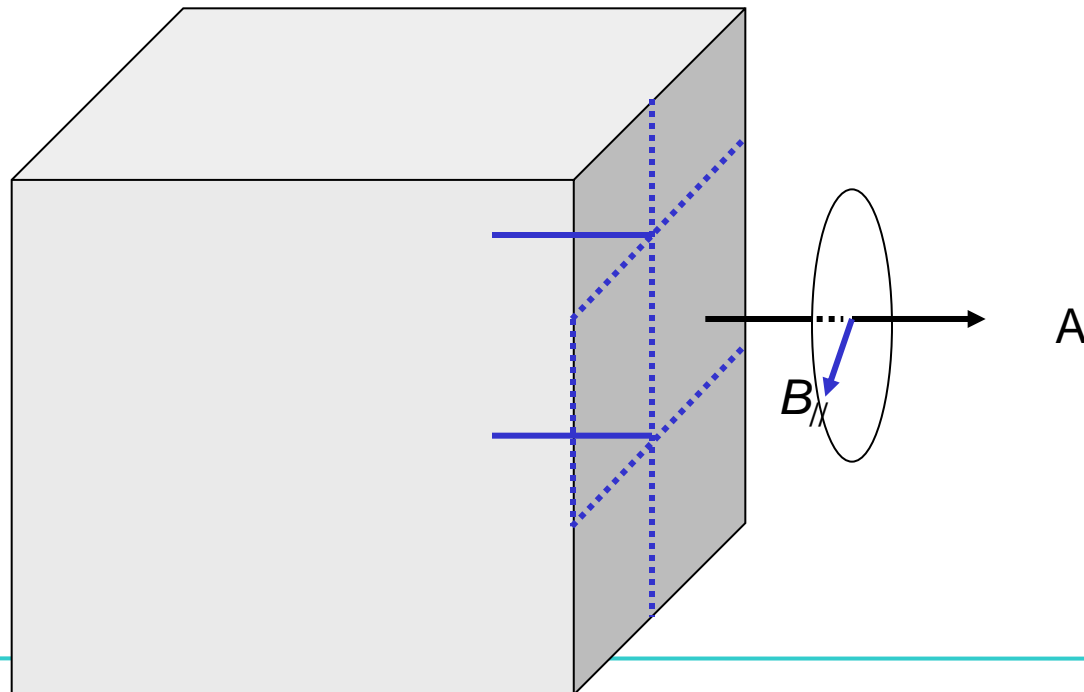
- ▶ *Let us start simple:* for a contact surface: $V = V_{\text{ext}}$
- ▶ This is a Dirichlet' boundary condition
- ▶ From TCAD, we borrow the idea that $E_n = \mathbf{E} \cdot \mathbf{n} = 0$ for non-contact boundary points

▶ Pure TCAD:
$$\mathbf{E} = -\nabla V \Rightarrow E_n = -\frac{\partial V}{\partial \mathbf{n}} = 0$$

▶ EM TCAD :
$$\mathbf{E} = -\nabla V - \frac{\partial \mathbf{A}}{\partial t} \Rightarrow E_n = -\frac{\partial V}{\partial \mathbf{n}} - \frac{\partial}{\partial t} (\mathbf{A} \cdot \mathbf{n}) = 0$$

Boundary conditions: Dirichlet

- ▶ We can extend the Dirichlet boundary conditions by taking $\mathbf{A} \cdot \mathbf{t} = 0$
- ▶ Since $\mathbf{B} = \text{curl } \mathbf{A}$ we have that \mathbf{B} is tangential to the surface



Boundary conditions: Dirichlet

- ▶ Do not forget the gauge condition!
- ▶ Simultaneous obeying Dirichlet's boundary conditions for A and the gauge condition requires that $A \cdot n|_{\text{in}}$ *and* $A \cdot n|_{\text{out}}$ and dV/dt are related
- ▶ **The gauge condition is void for these boundary condition, since its evaluation requires the variable $A \cdot n$ from the outside which is not part of the set of degrees of freedom**
- ▶ As a consequence , for links bouncing on the surface of the simulation domain, the gauge condition should not be inserted for lifting the singular character of

$$\nabla \times \nabla \times \mathbf{A}$$

Boundary conditions: Neumann

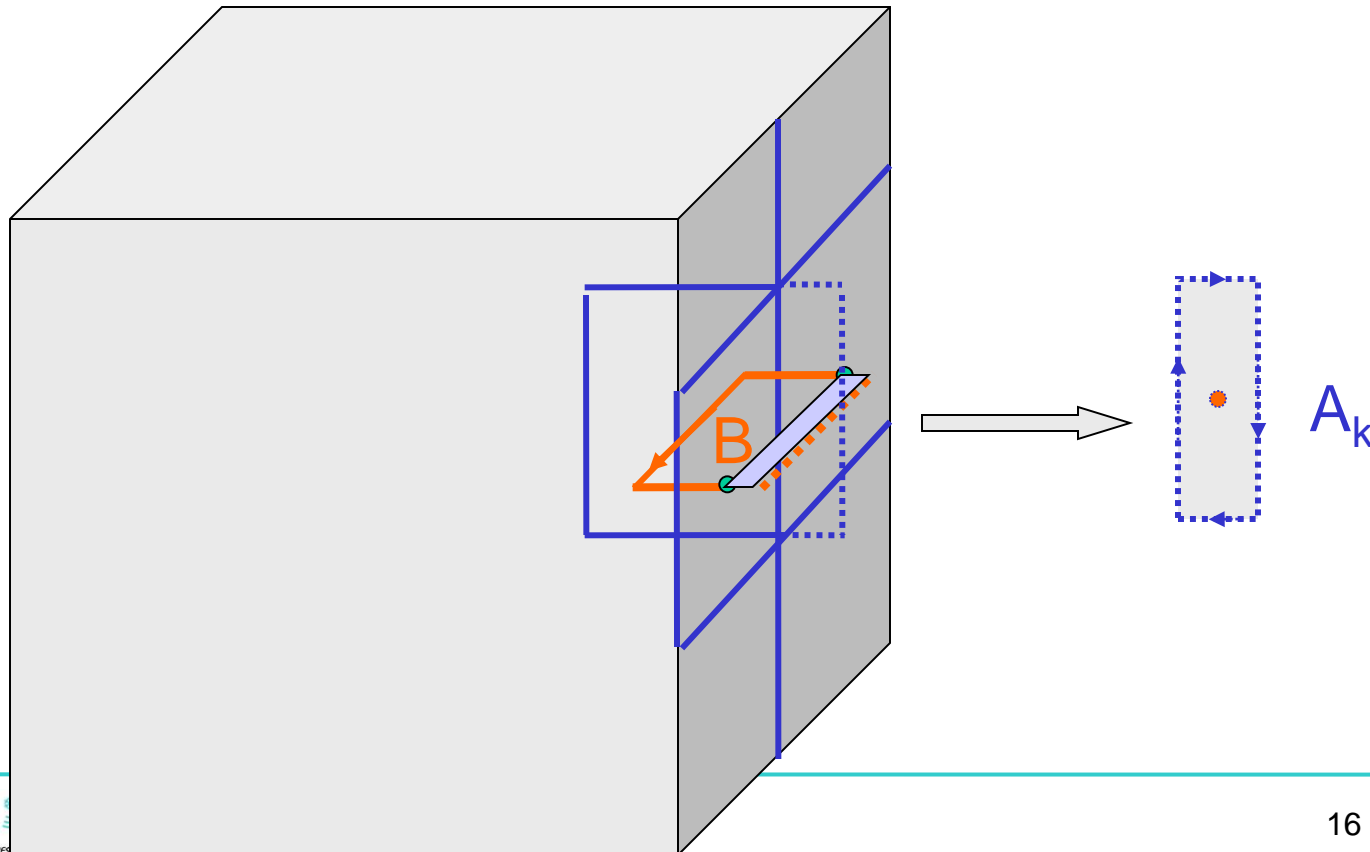
- ▶ We can start from Neumann boundary conditions for **A**
- ▶ 90° Mur boundary conditions for potentials is implemented



Boundary conditions: Neumann

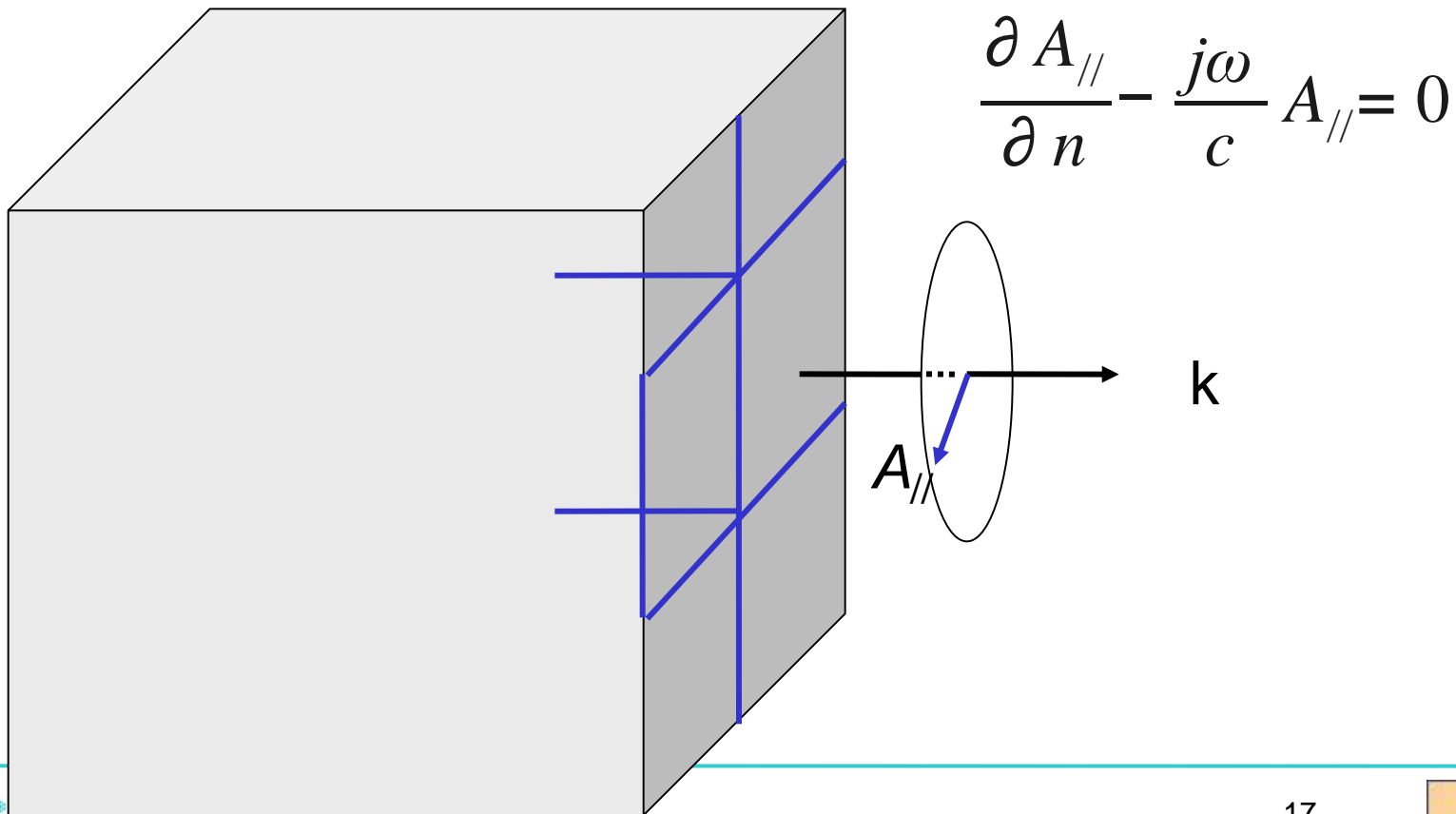
- ▶ Missing '**B**' can be assigned to

$$\frac{\partial A_{//}}{\partial n}$$



Boundary conditions: Neumann

$\frac{\partial A_{//}}{\partial n}$ can be assigned to radiation of TE wave



Boundary conditions overview

Default EM-TCAD	Radiative
V : Dirichlet at contact V : Neumann at non-contact	V : Dirichlet at contact V : Dirichlet at non-contact (e.g. $V=0$)
$A_{//}$: Dirichlet	$A_{//}$: Neumann
A_{\perp} : match of gauge condition	A_{\perp} : match of gauge condition

Conclusions

- ▶ Interface conditions are non-trivial for EM+TCAD
- ▶ Boundary conditions require a careful analysis concerning
 - Desired character of the boundary condition
 - Discretization scheme
 - Respecting the gauge condition

